

1 Characteristics

Table 2. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter		Value	Unit
V_{PP}	Peak pulse voltage	ISO 10605 (C = 330 pF, R = 330 Ω)		
		– contact discharge	30	
		– air discharge	30	
		IEC 61000-4-2		
		– contact discharge	30	
		– air discharge	30	
T_{stg}	Storage temperature range		-65 to + 175	$^{\circ}\text{C}$
T_j	Operating junction temperature range		-55 to + 175	$^{\circ}\text{C}$
T_L	Maximum lead temperature for soldering during 10 s		260	$^{\circ}\text{C}$

Table 3. Thermal parameter

Symbol	Parameter		Maximum	Unit
$R_{th(j-c)}$	Junction to case	D ² PAK	0.24	$^{\circ}\text{C/W}$

Figure 1. Electrical characteristics (definitions)

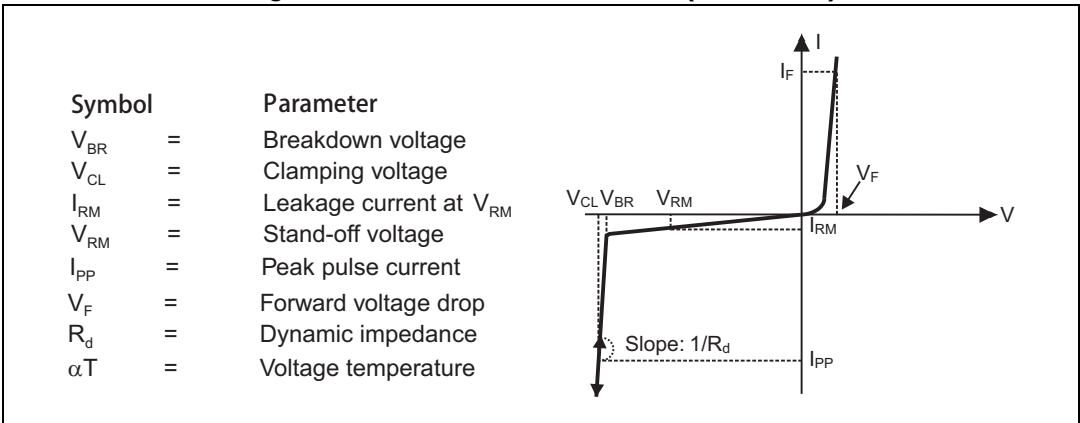


Figure 2. Pulse definition for electrical characteristics

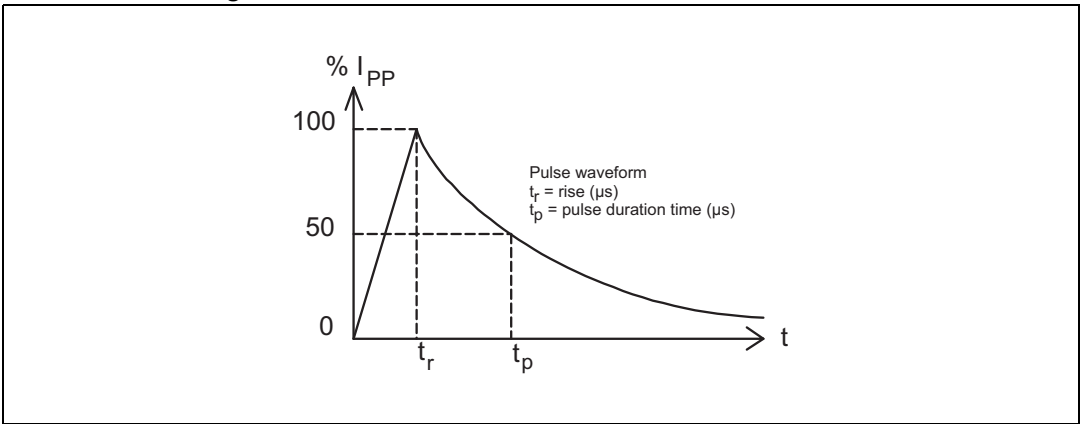


Table 4. Electrical characteristics (parameter)

Order code	I_{RM} max. at V_{RM}			V_{BR} at $I_R^{(1)}$				V_{CL} at I_{PP} 10/1000 μs		$R_D^{(2)}$ 10/1000 μs	V_{CL} at I_{PP} 8/20 μs		$R_D^{(2)}$ 8/20 μs	$\alpha T^{(3)}$
	25 °C	175 °C		min.	typ.	max.		max.			max.			max.
	μA		V	V			mA	V	A	m Ω	V	A	m Ω	$10^{-4}/^{\circ}C$
LDP01-26AY	1	100	22	24.4	26	27.0	1	36	140	64	42	1400	11	9.6
LDP01-28AY	1	100	24	26.7	28	29.5	1	40	120	88	45	1250	12	9.7
LDP01-30AY	1	100	27	28.9	30	31.9	1	40	125	65	49	1400	12	9.7
LDP01-33AY	1	100	28	31.1	33	34.3	1	43.5	110	75	56	1250	17	9.8
LDP01-35AY	1	100	30	33.3	35	36.9	1	45.5	95	91	60	1150	20	9.9
LDP01-39AY	1	100	33	36.7	39	40.5	1	51.5	85	129	66	1050	24	10
LDP01-42AY	1	100	36	40	42	44.2	1	57	77	166	71	1000	27	10
LDP01-47AY	1	100	40	44.4	47	49	1	63	65	215	76.5	950	29	10.1
LDP01-50AY	1	100	43	47.8	50	52.8	1	68	55	276	81	900	31	10.2
LDP01-56AY	1	100	48	53.3	56	58.9	1	76	48	356	90	770	40	10.3
LDP01-68AY	1	100	58	64.4	68	71.2	1	92	42	495	110	620	63	10.4
LDP01-82AY	1	100	70	77.8	82	86	1	113	35	771	135	550	89	10.5

1. Pulse test: $t_p < 50$ ms

2. To calculate maximum clamping voltage at other surge level, use the following formula: $V_{CL\max} = R_D \times I_{PP} + V_{BR\max}$

3. To calculate V_{BR} or V_{CL} versus junction temperature, use the following formulas:

$$V_{BR} \text{ at } T_j = V_{BR} \text{ at } 25^{\circ}C \times (1 + \alpha T \times (T_j - 25))$$

$$V_{CL} \text{ at } T_j = V_{CL} \text{ at } 25^{\circ}C \times (1 + \alpha T \times (T_j - 25))$$

Figure 3. Peak pulse power dissipation versus initial junction temperature (LDP01-30AY)

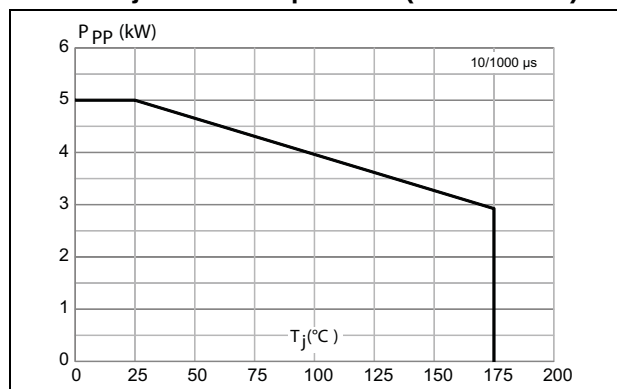


Figure 4. Peak pulse power versus exponential pulse duration (LDP01-30AY)

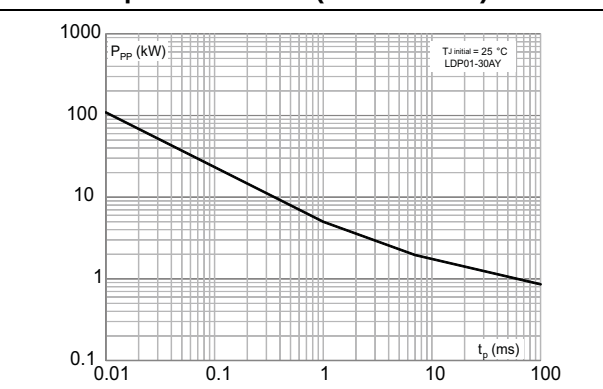


Figure 5. ISO7637-2, pulse 5a definition

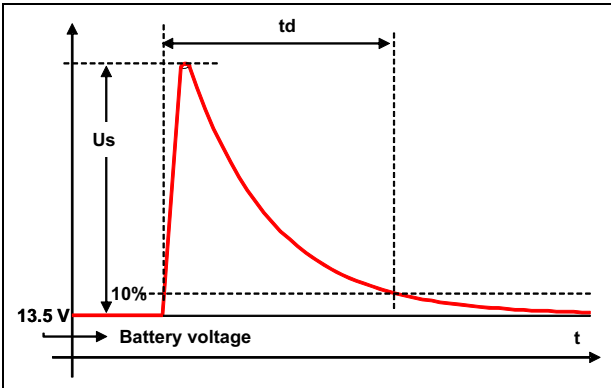


Figure 6. Load dump capability (LDP01-30AY)
 $U_s = f(R_i)$ pulse 5a)

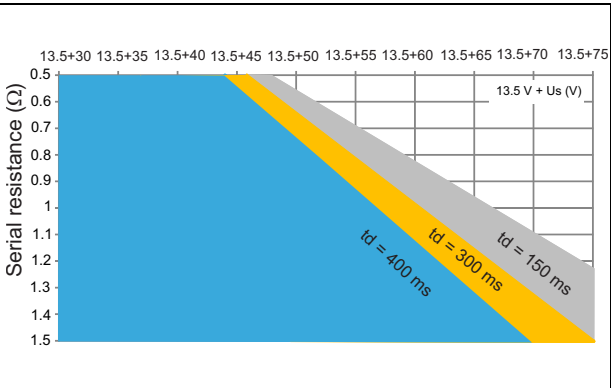


Figure 7. ISO7637-2, pulse 5b definition

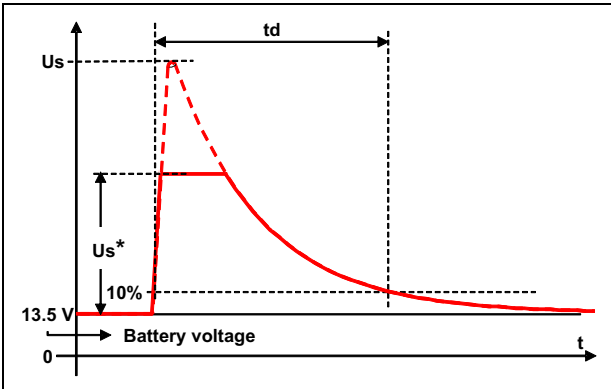


Figure 8. Load dump capability (LDP01-30AY)
 $U_{s^*} = f(R_i)$ pulse 5b, $U_s = 87$ V)

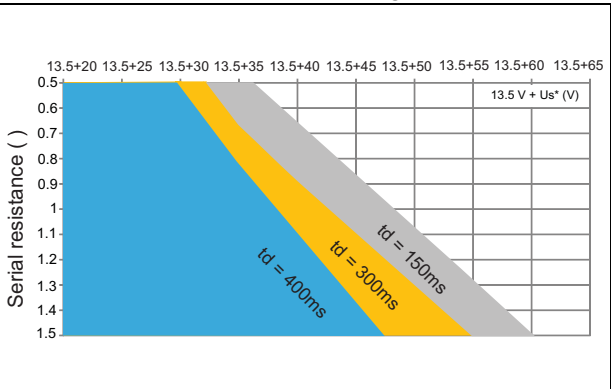


Figure 9. ISO 16750-2, test A definition

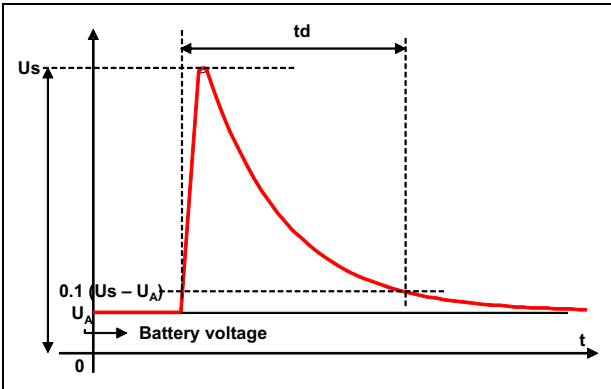


Figure 10. Load dump capability (LDP01-30AY)
 $U_s = f(R_i)$, Test A)

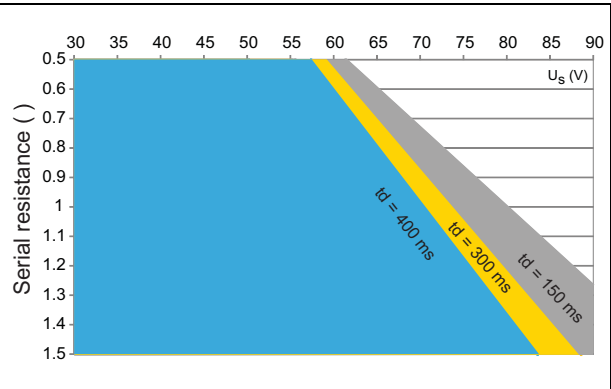


Figure 11. ISO 16750-2, test B definition

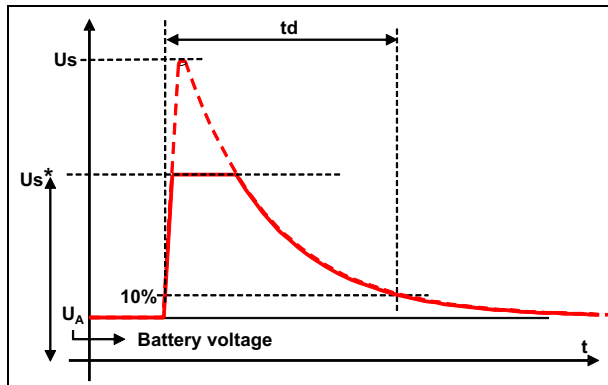
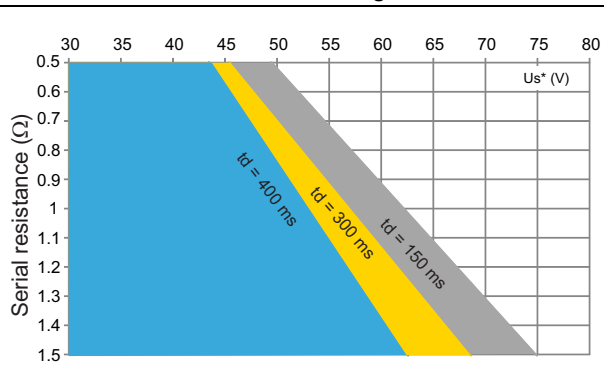
Figure 12. Load dump capability (LDP01-30AY)
 $U_s^* = f(R_i)$ Test B, $U_s = 87 \text{ V}$ 

Figure 13. Clamping voltage versus peak pulse current (maximum values)

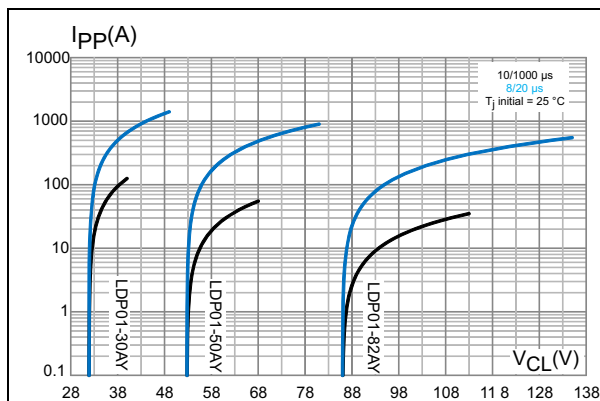
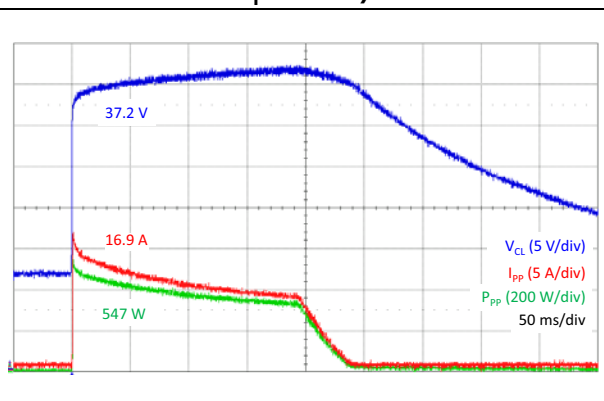
Figure 14. ISO 16750-2 test B response
($U_A + U_s^* = 13.5 + 30 \text{ V}$, $U_s = 87 \text{ V}$, $t_d = 400 \text{ ms}$,
 $R_i = 0.5 \Omega$)

Figure 15. Peak forward voltage versus peak forward current (typical values)

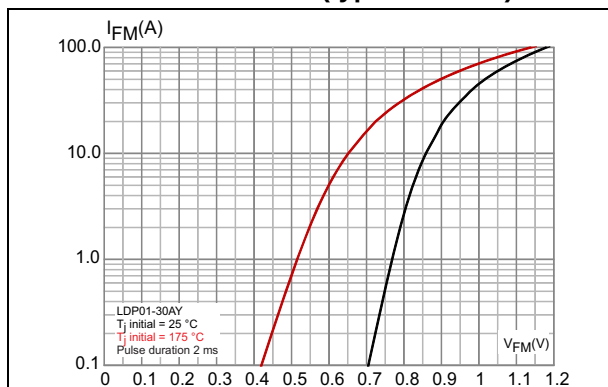


Figure 16. Leakage current versus junction temperature (typical values)

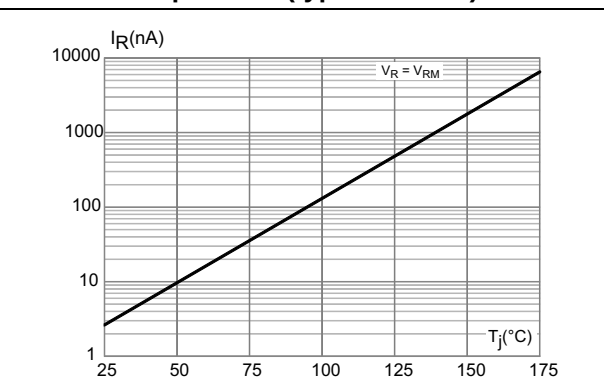
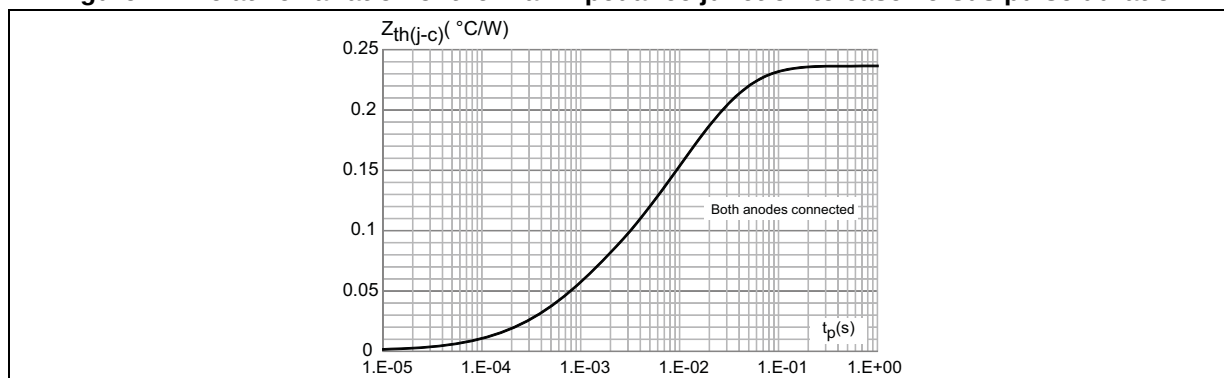


Figure 17. Relative variation of thermal impedance junction to case versus pulse duration

More information available in AN2689 on www.st.com: Protection of automotive electronics from electrical hazards, guidelines for design and component selection.

2 Package information

- Epoxy meets UL94, V0

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at www.st.com. ECOPACK® is an ST trademark.

Figure 18. D²PAK dimension definitions

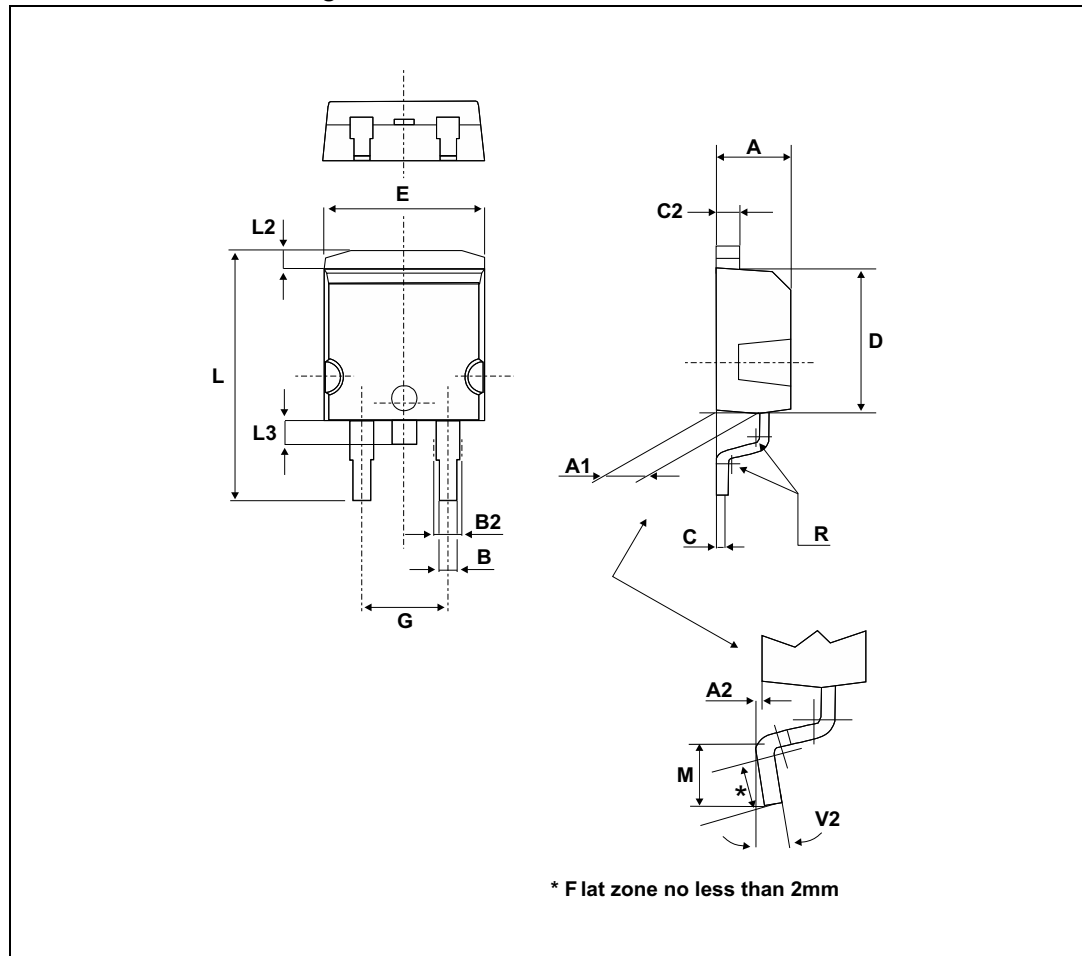


Table 5. D²PAK dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
B	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
C	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
E	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.30	1.75	0.051	0.069
M	2.29	2.79	0.090	0.110
R	0.40 typ.		0.016 typ.	
V2	0°	8°	0°	8°

Figure 19. Footprint (dimensions in mm)

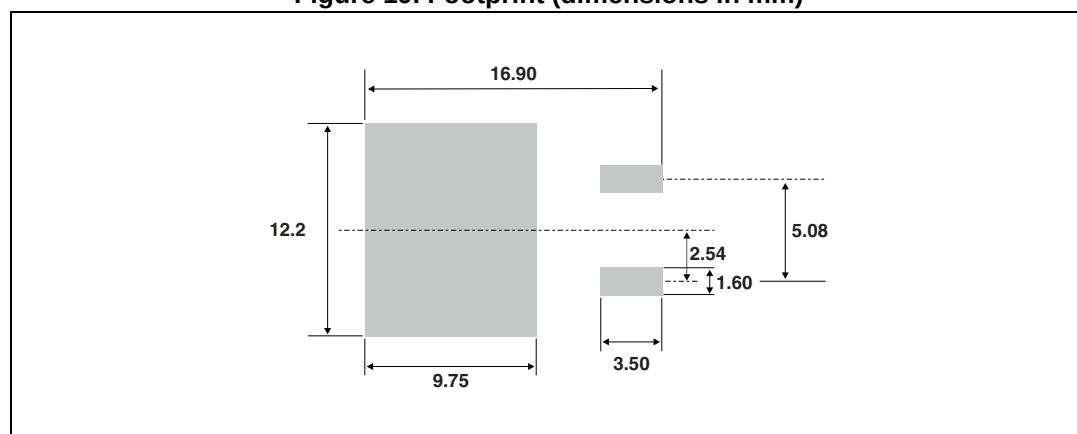
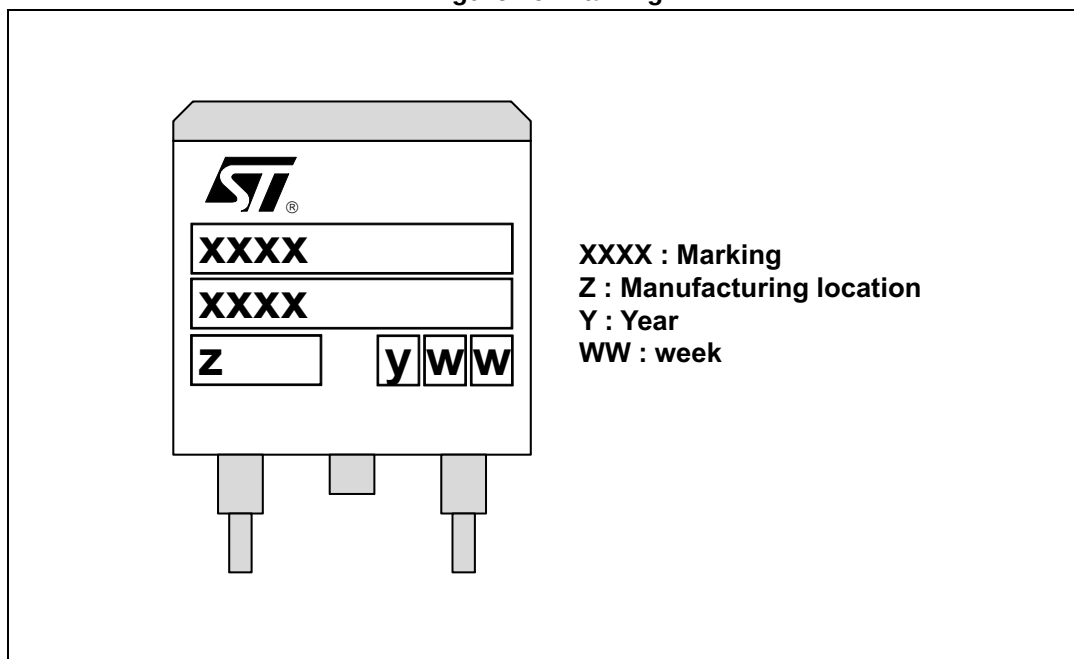


Figure 20. Marking



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
LDP01-26AY	LDP01-26AY	D ² PAK	1.38 g	1000	Tape and reel
LDP01-28AY	LDP01-28AY				
LDP01-30AY	LDP01-30AY				
LDP01-33AY	LDP01-33AY				
LDP01-35AY	LDP01-35AY				
LDP01-39AY	LDP01-39AY				
LDP01-42AY	LDP01-42AY				
LDP01-47AY	LDP01-47AY				
LDP01-50AY	LDP01-50AY				
LDP01-56AY	LDP01-56AY				
LDP01-68AY	LDP01-68AY				
LDP01-82AY	LDP01-82AY				

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
26-Nov-2014	1	Initial release.
01-Oct-2015	2	Added wildcard character in part number on the cover page. Updated Figure 4 . Minor text changes.

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